IPC ASSOCIATION ELECTRONICS	© Copyright 2005. I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reducting international and Pan-American copyright conventions.			nder both			n of the substance compasses all low						
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				rials and Mfg Information				
upplier	Information													
Company name* Company unique ID					Unique ID Authority				Respo	Response Date*				
nsemi											2025-06-06			
Contact Name Title - Contact				et	Phone - Contact*			Emai	Email - Contact*					
Product-Env-Stewards Produ				Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				entative	Phone - Representative* Email - Representative			ve*						
Product-Env-Stewards Product Enviro Compliance				ı	NA Product-Env-Stewards@onsemi.co					0 m				
	Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Version	Manufacturing S	Site	Weight*	UOM	Unit Type	
		NXH450 1G)N65L4Q2F2S	120kW 1100V Q2	2PACK	:	2025-06-06		CNG		176090.14	mg	Each	
lanufac	turing Process Informa	tion												
,	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 MSI		Rating	Peak Process Body Temperature Max Time at Po		t Peak Tempe	rature Numbe	r of Reflow Cy	cles			
Matte Tin (Sn) - annealed		CU Alloy NA		NA	0		С 30		sec	seconds 3				

RoHS Material Composition Declaration			Declaration Type *	Detail	led
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an		
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the co	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not e at least as comprehensive as the hts and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3615.5	mg
			Supplier	PBT	26062-94-2		6714.4995	mg
Case Lid	6690.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2341.5	mg
			Supplier	PBT	26062-94-2		4348.5	mg
DBC	17490.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		3830.3101	mg
			Supplier	Copper (Cu)	7440-50-8		13659.6895	mg
Die	340.144	mg	Supplier	Silicon (Si)	7440-21-3		340.144	mg
Die Attach Solder	780.0	mg	Supplier	Silver (Ag)	7440-22-4		31.2	mg
			Supplier	Tin (Sn)	7440-31-5		744.9	mg
			Supplier	Misc.	Proprietary Data		3.9	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	4260.0	mg	Supplier	Silver (Ag)	7440-22-4		127.8	mg
			Supplier	Tin (Sn)	7440-31-5		4110.8999	mg
			Supplier	Copper (Cu)	7440-50-8		21.3	mg
Terminal	3540.0	mg	Supplier	Silicon (Si)	7440-21-3		9.558	mg
			В	Nickel (Ni)	7440-02-0		47.79	mg
			Supplier	Copper (Cu)	7440-50-8		3481.7671	mg
			Supplier	Phosphorus (P)	7723-14-0		0.885	mg

							1	
Wire Bond - Al	390.0	mg	Supplier	Aluminum (Al)	7429-90-5		390	mg
wire Bond - Ai	1370.0	IIIg	Bupplier	Aluminum (Al)	1747-70-3	I	1370	mg